Unit: mm

TOSHIBA Transistor Silicon PNP Epitaxial Type (PCT Process)

HN1A01F

Audio-Frequency General-Purpose Amplifier Applications

Small package (dual type)

High voltage and high current

: $V_{CEO} = -50 \text{ V}$, $I_{C} = -150 \text{ mA (max)}$

High h_{FE} : $h_{FE} = 120~400$

Excellent h_{FE} linearity

: $h_{FE} (I_C = -0.1 \text{ mA}) / h_{FE} (I_C = -2 \text{ mA}) = 0.95 \text{ (typ.)}$

Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristic	Symbol	Rating	Unit
Collector-base voltage	V _{CBO}	-50	V
Collector-emitter voltage	V _{CEO}	-50	V
Emitter-base voltage	V _{EBO}	-5	٧
Collector current	I _C	-150	mA
Base current	Ι _Β	-30	mA
Collector power dissipation	Pc*	300	mW
Junction temperature	Tj	125	°C
Storage temperature range	T _{stg}	-55~125	°C



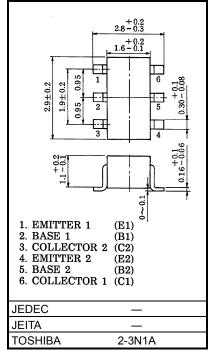
Electrical Characteristics (Ta = 25°C) (Q1, Q2 Common)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}	_	V _{CB} = -50 V, I _E = 0	_	_	-0.1	μΑ
Emitter cut-off current	I _{EBO}	_	$V_{EB} = -5 \text{ V}, I_{C} = 0$	_	_	-0.1	μΑ
DC current gain	h _{FE} (note)	_	$V_{CE} = -6 \text{ V}, I_{C} = -2 \text{ mA}$	120	_	400	
Collector-emitter saturation voltage	V _{CE (sat)}	_	I _C = −100 mA, I _B = −10 mA	_	-0.1	-0.3	V
Transition frequency	f _T	_	V _{CE} = −10 V, I _C = −1 mA	80	_	_	MHz
Collector output capacitance	C _{ob}	_	V _{CB} = -10 V, I _E = 0, f = 1 MHz	_	4	7	pF

Note:hFE Classification

Y (Y): 120~240, GR (G): 200~400

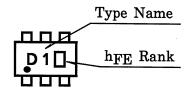
() Marking Symbol

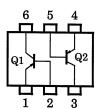


Weight: 0.015 g (typ.)

Marking

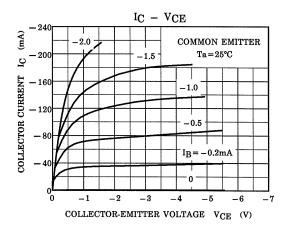
Equivalent Circuit (Top View)

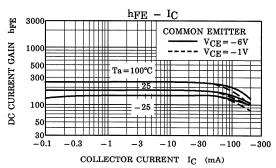


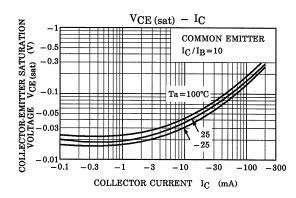


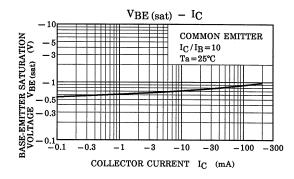
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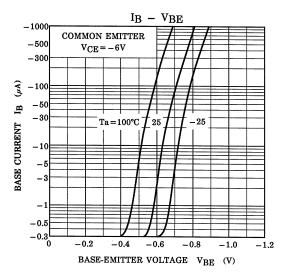
(Q1, Q2 Common)

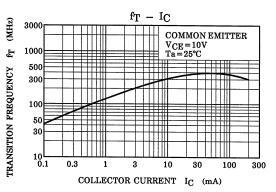


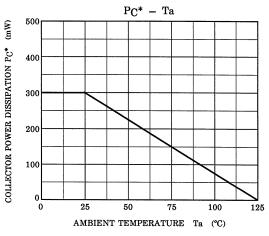












* : Total Rating

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